

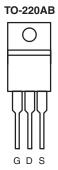
# 2SK3479-Z-VB Datasheet N-Channel 100-V (D-S) 175 °C MOSFET

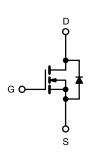
PRODUCT SUMMARY				
V <sub>DS</sub> (V)	100			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$	0. 009			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 4.5 \text{ V}$	0. 020			
I <sub>D</sub> (A)	100			
Configuration	Single			

#### **FEATURES**

- TrenchFET® Power MOSFET
- 175 °C Maximum Junction Temperature
- Compliant to RoHS Directive 2002/95/EC







N-Channel MOSFET

 $T_J$ ,  $T_{stg}$ 

- 55 to 175

<b>ABSOLUTE MAXIMUM RATINGS</b> T <sub>A</sub> = 25 °C, unless otherwise noted						
Parameter			Limit	Unit		
Drain-Source Voltage		$V_{DS}$	100			
Gate-Source Voltage		$V_{GS}$	± 20	V		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C	I_	100	Δ		
	T <sub>C</sub> = 125 °C	ΙD	75 <sup>a</sup>			
Pulsed Drain Current		I <sub>DM</sub>	300	Α		
Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	75			
Single Pulse Avalanche Energy <sup>b</sup>	L = U.1 MID	E <sub>AS</sub>	280	mJ		
Mariana Barra Birata da b	T <sub>C</sub> = 25 °C (TO-220AB and TO-263)		250 <sup>c</sup>	W		
Maximum Power Dissipation <sup>b</sup>	$T_A = 25 ^{\circ}\text{C}  (\text{TO-}263)^d$	ı D	3.75	l vv		

THERMAL RESISTANCE RATINGS				
Parameter		Symbol	Limit	Unit
Junction-to-Ambient	PCB Mount (TO-263) <sup>d</sup>	- R <sub>thJA</sub>	40	°C/W
Junction-to-Ambient	Free Air (TO-220AB)	— PthJA	62.5	
Junction-to-Case		R <sub>thJC</sub>	0.6	

#### Notes

a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.

Operating Junction and Storage Temperature Range

- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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°С



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{DS}$ $V_{GS} = 0 \text{ V, } I_D = 250 \mu\text{A}$				v
Gate-Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2		4	V
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current		V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V			1	
	I <sub>DSS</sub>	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C			50	-
		V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 175 °C			250	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} = \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	120			Α
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 30 A		0.009		
D	D.	$V_{GS} = 4.5 \text{ V}, I_{D} = 20 \text{ A}$		0.020		_
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 30 A, T <sub>J</sub> = 125 °C		0.023		Ω
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 30 A, T <sub>J</sub> = 175 °C		0.030		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 30 A	25			S
Dynamic <sup>b</sup>						
Input Capacitance	C <sub>iss</sub>			4700		pF
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		665		
Reverse Transfer Capacitance	C <sub>rss</sub>	7		265		
Total Gate Charge <sup>c</sup>	$Q_g$			105	160	
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 85 \text{ A}$		17		nC
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>	7		23		
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			12	25	
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD} = 50 \text{ V}, R_{L} = 0.6 \Omega$		90	135	
Turn-Off DelayTime <sup>c</sup>	t <sub>d(off)</sub>	$I_D\cong 85$ A, $V_{GEN}=10$ V, $R_g=2.5~\Omega$		55	85	ns
Fall Time <sup>c</sup>	t <sub>f</sub>	7		130	195	
Source-Drain Diode Ratings and Char	racteristics T <sub>C</sub>	= 25 °C <sup>b</sup>				
Continuous Current	Is				85	^
Pulsed Current	I <sub>SM</sub>				240	Α
Forward Voltage <sup>a</sup>	V <sub>SD</sub>	I <sub>F</sub> = 85 A, V <sub>GS</sub> = 0 V		1.0	1.5	V
Reverse Recovery Time	t <sub>rr</sub>			85	140	ns
Peak Reverse Recovery Current	I <sub>RM(REC)</sub>	I <sub>F</sub> = 50 A, dI/dt = 100 A/μs		4.5	7	Α
Reverse Recovery Charge	Q <sub>rr</sub>	1		0.17	0.35	μС

### Notes:

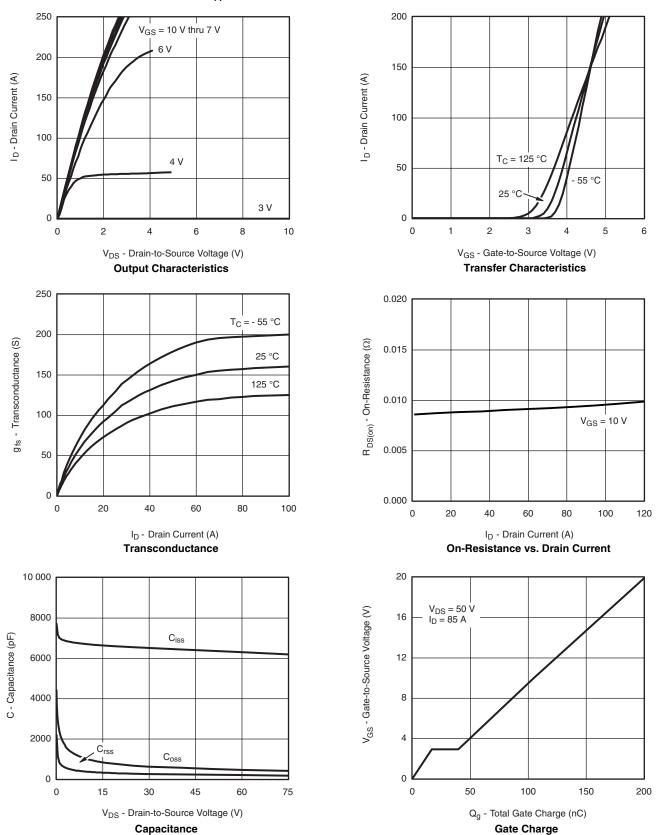
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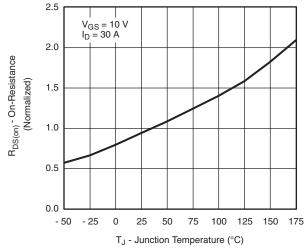
### **TYPICAL CHARACTERISTICS** $T_A = 25$ °C, unless otherwise noted



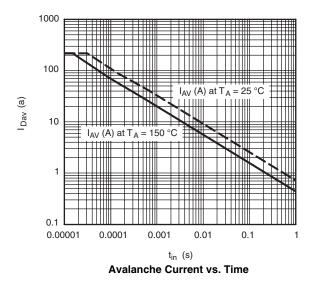
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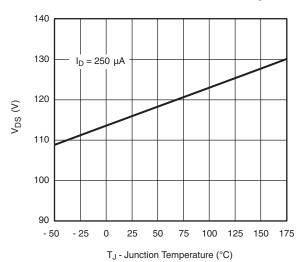
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### On-Resistance vs. Junction Temperature



Source-Drain Diode Forward Voltage

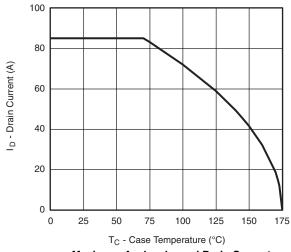


T<sub>J</sub> - Drain-Source Breakdown vs. Junction-Temperature

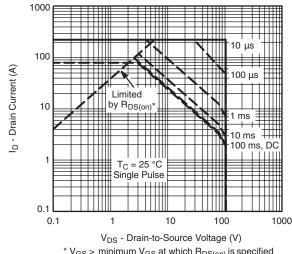
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### **THERMAL RATINGS**

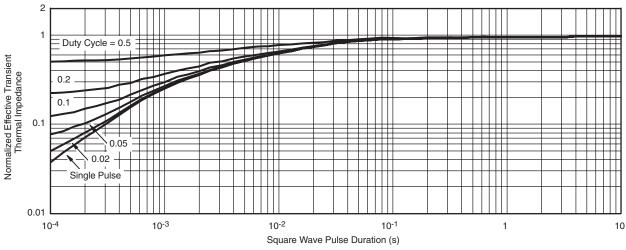


Maximum Avalanche and Drain Current vs. Case Temperature



\*  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

Safe Operating Area



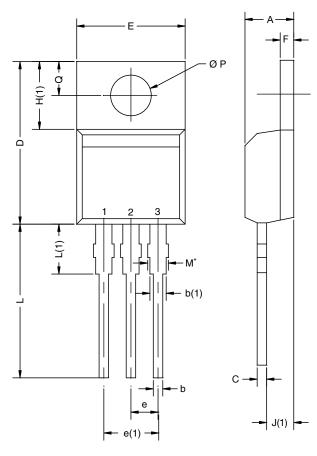
Normalized Thermal Transient Impedance, Junction-to-Case

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## **TO-220AB**



	D2

	MILLIN	IETERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.25	4.65	0.167	0.183
b	0.69	1.01	0.027	0.040
b(1)	1.20	1.73	0.047	0.068
С	0.36	0.61	0.014	0.024
D	14.85	15.49	0.585	0.610
D2	12.19	12.70	0.480	0.500
E	10.04	10.51	0.395	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.09	6.48	0.240	0.255
J(1)	2.41	2.92	0.095	0.115
L	13.35	14.02	0.526	0.552
L(1)	3.32	3.82	0.131	0.150
ØΡ	3.54	3.94	0.139	0.155
Q	2.60	3.00	0.102	0.118
ECN: T14-0413-Rev. P, 16-Jun-14 DWG: 5471				

### Note

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 $<sup>^{\</sup>star}$  M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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